

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Heinrich Schenk	11/08/2006
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Infineon Technologies AG
<b>Street Address:</b>	St.-Martin-Str. 53
<b>City:</b>	Muenchen
<b>State/Country:</b>	GERMANY
<b>Postal Code:</b>	81669
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	11534952
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(512)322-8383
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	5123222601
<b>Email:</b>	apatent@bakerbotts.com
<b>Correspondent Name:</b>	Baker Botts L.L.P.
<b>Address Line 1:</b>	Andreas Grubert (068758.0488)
<b>Address Line 2:</b>	98 San Jacinto Blvd., Suite 1500
<b>Address Line 4:</b>	Austin, TEXAS 78701-4039
<b>ATTORNEY DOCKET NUMBER:</b>	068758.0488
<b>NAME OF SUBMITTER:</b>	Adesewa Faleti
<b>Total Attachments: 1</b> source=068758.0488#page1.tif	

**CH \$40.00 11534952**

INVENTOR REF NO. 1108018  
D.C. REF NO. 06875x,0485

ASSIGNMENT

For good and valuable consideration, I, Heinrich Schenk, a citizen of Germany, residing at Fatimastr. 3, 81476 München, Germany, hereinafter referred to as "Assignor":

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the state laws of Germany, having its principal place of business at St. Martin Str. 53, D-81669 München, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned assigned application serial number 11:534,952 filed on September 25, 2006, and entitled:

**"POWER LEVEL SETTINGS FOR TRANSMISSION LINES"**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives, and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned

Full name of sole inventor

HEINRICH SCHENK

Inventor's Signature

Heinrich Schenk

Date

Nov. 5, 2006

AUS01:440995.1

1/1